

**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

**Claims 1-24 (canceled).**

**Claim 25 (previously presented):** A printed circuit board unit with a cooling device, comprising:

a printed circuit board;

a ventilation fan coupled to the printed circuit board for relative rotation to the printed circuit board, said ventilation fan having a rotation axis and a direction of said rotation axis intersecting the printed circuit board;

a housing wall standing from a surface of the printed circuit board at a periphery of the ventilation fan;

an outlet defined in the housing wall;

an electronic component mounted on the printed circuit board outside the housing wall; and

an electrically conductive wiring pattern extending over the surface of the printed circuit board inside the housing wall and connected to the electronic component.

**Claim 26 (previously presented):** The printed circuit board unit with the cooling device according to claim 25, further comprising a radiation fin connected to the electrically conductive wiring pattern.

**Claim 27 (previously presented):** The printed circuit board unit with the cooling device according to claim 25, wherein the electronic component is a central processing unit.

**Claims 28 -29 (canceled).**

**Claim 30 (previously presented):** An electronic apparatus comprising:

- a printed circuit board;
- a ventilation fan coupled to the printed circuit board for relative rotation to the printed circuit board, said ventilation fan having a rotation axis and a direction of said rotation axis intersecting the printed circuit board;
- a housing wall standing from a surface of the printed circuit board at a periphery of the ventilation fan;
- an outlet defined in the housing wall;
- an electronic component mounted on the printed circuit board outside the housing wall; and
- an electrically conductive wiring pattern extending over the surface of the printed circuit board inside the housing wall and connected to the electronic component.

**Claim 31 (previously presented):** The electronic apparatus according to claim 30, further comprising a radiation fin connected to the electrically conductive wiring pattern.

**Claim 32 (previously presented):** The electronic apparatus according to claim 30, wherein the electronic component is a central processing unit.

**Claims 33-36 (canceled).**